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April 2015

FDD390N15A

N-Channel PowerTrench[®] MOSFET 150 V, 26 A, 40 m Ω

Features

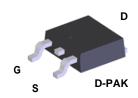
- $R_{DS(on)}$ = 33.5 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 26 A
- · Fast Switching Speed
- Low Gate Charge, Q_G = 14.3 nC(Typ.)
- High Performance Trench Technology for Extremely Low $R_{\mbox{\footnotesize{DS(on)}}}$
- · High Power and Current Handling Capability
- · RoHS Compliant

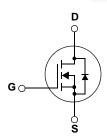
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- · Consumer Appliances
- LED TV
- · Synchronous Rectification
- · Uninterruptible Power Supply
- Micro Solar Inverter





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter		FDD390N15A	Unit
V _{DSS}	Drain to Source Voltage			150	V
V	Cata to Source Valtage	- DC		±20	V
V_{GSS}	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V
I _D	- Continuous (T _C = 25°C, Silicon Limited)			26	Α
	Diain Curient	- Continuous (T _C = 100°C,	Silicon Limited)	17	^
I _{DM}	Drain Current	- Pulsed	(Note 1)	104	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		78	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	6.0	V/ns
В	Power Dissipation	$(T_C = 25^{\circ}C)$		63	W
P_{D}	Power Dissipation - Derate above 25°C			0.5	W/°C
T _J , T _{STG}	Operating and Storage Temp	Operating and Storage Temperature Range			°C
T _L	Maximum Lead Temperature 1/8" from Case for 5 Second	•		300	°C

Thermal Characteristics

Symbol	Parameter	FDD390N15A	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	87	C/VV

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDD390N15A	FDD390N15A	DPAK	Tape and Reel	330 mm	16 mm	2500 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	150	-	-	V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C	-	0.1	-	V/°C
	Zara Cata Valtaga Drain Current	V _{DS} = 120 V, V _{GS} = 0 V	-	-	1	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 120 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	-	500	μА
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.0	-	4.0	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$	-	33.5	40	mΩ
g _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_{D} = 26 \text{ A}$	-	33	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 75 V V 0 V	-	965	1285	pF
Coss	Output Capacitance	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$ 	\-	96	130	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1 1011 12	-\	5.8	-	pF
C _{oss(er)}	Energy Related Output Capacitance	V _{DS} = 75 V, V _{GS} = 0 V		169	-	pF
Q _{g(tot)}	Total Gate Charge at 10V		-	14.3	18.6	nC
Q _{gs}	Gate to Source Gate Charge	$V_{DS} = 75 \text{ V}, I_{D} = 27 \text{ A}$		5.0	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau	V _{GS} = 10 V	-	2.0	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	(Note 4)	-	3.5	-	nC
ESR	Equivalent Series Resistance (G-S)	f = 1 MHz	-	1.4	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	14	38	ns
t _r		$V_{DD} = 75 \text{ V}, I_{D} = 27 \text{ A}$	- /	10	30	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 4.7 \Omega$	-	20	50	ns
t _f	Turn-Off Fall Time	(Note 4)	/-	5	20	ns

Drain-Source Diode Characteristics

I _S	Maximum Continuous Drain to Source Diode Forward Current			-	26	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	104	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 26 A	-	-	1.25	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 27 A, V _{DD} = 75 V	-	63	-	ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	131	-	nC

Notes:

- Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. Starting $T_J=25^{\circ}C,\ \ L=3$ mH, $I_{SD}=7.2$ A
- 3. $I_{SD} \le 26$ A, di/dt ≤ 200 A/ μs , $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$
- 4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

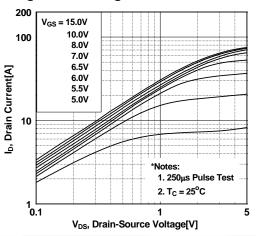


Figure 3. On-Resistance Variation vs.
Drain Current and Gate Voltage

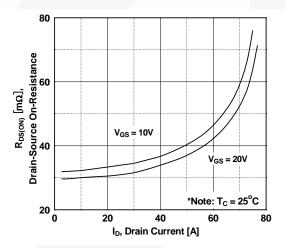


Figure 5. Capacitance Characteristics

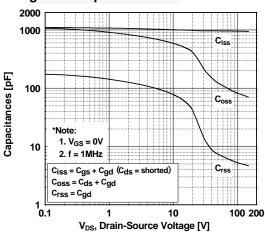


Figure 2. Transfer Characteristics

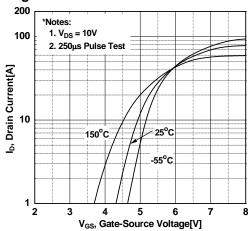


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

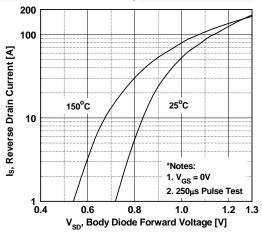
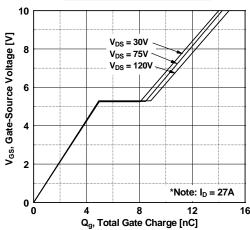


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

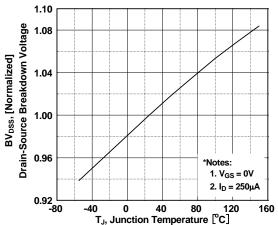


Figure 9. Maximum Safe Operating Area

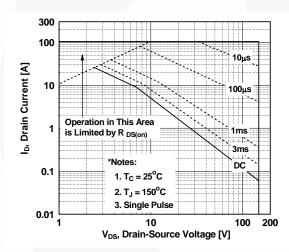


Figure 11. Eoss vs. Drain to Source Voltage

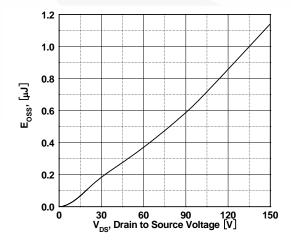


Figure 8. On-Resistance Variation vs. Temperature

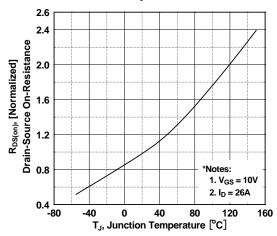


Figure 10. Maximum Drain Current vs. Case Temperature

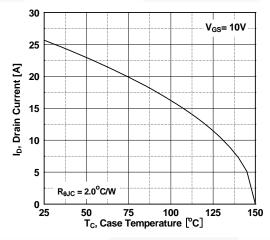
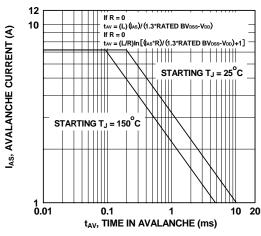
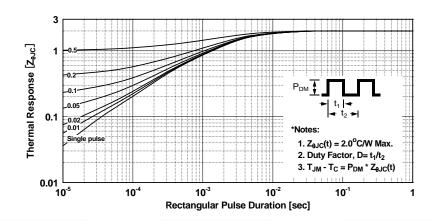


Figure 12. Unclamped Inductive Switching Capability



Typical Performance Characteristics (Continued)

Figure 13. Transient Thermal Response Curve



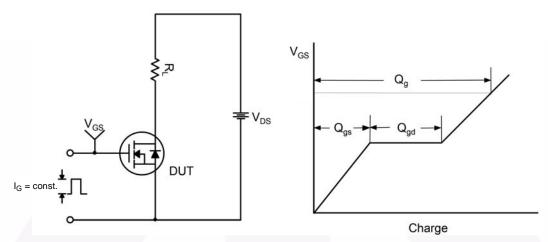


Figure 14. Gate Charge Test Circuit & Waveform

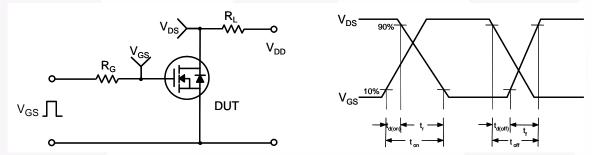


Figure 15. Resistive Switching Test Circuit & Waveforms

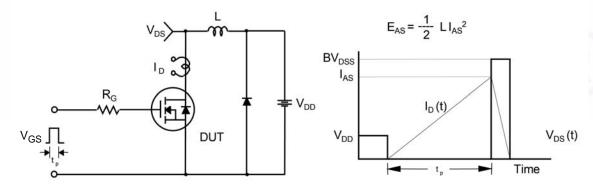


Figure 16. Unclamped Inductive Switching Test Circuit & Waveforms

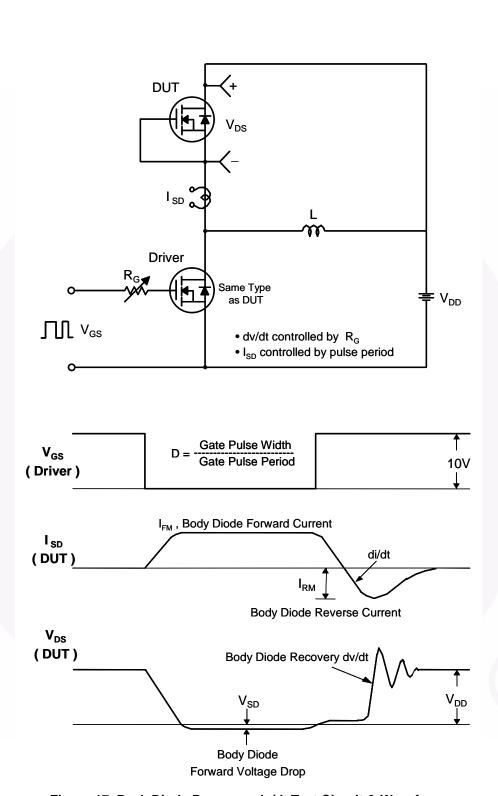
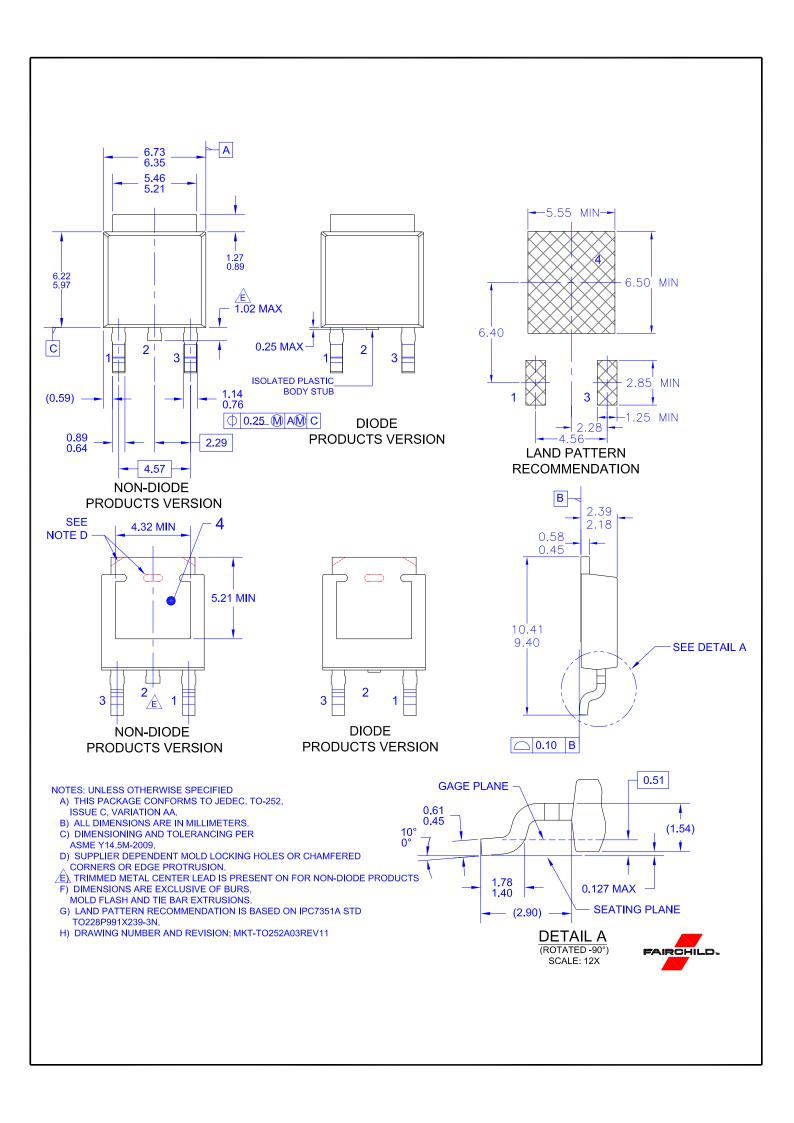


Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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